

1. General description

Planar passivated Silicon Controlled Rectifier (SCR) in a SOT186A (TO-220F) "full pack" plastic package intended for use in applications requiring high bidirectional blocking voltage and high current surge capability with high thermal cycling performance.

2. Features and benefits

- High bidirectional blocking voltage capability
- · High current surge capability
- High thermal cycling performance
- Isolated mounting base package
- Planar passivated for voltage ruggedness and reliability

3. Applications

- Capacitive Discharge Ignition (CDI)
- Crowbar protection
- Inrush protection
- Motor control
- Voltage regulation

4. Quick reference data

| Table 1. Quick reference data | Table ⁴ | 1. | Quick | reference | data |
|-------------------------------|--------------------|----|-------|-----------|------|
|-------------------------------|--------------------|----|-------|-----------|------|

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|--|--|-----|-----|-----|------|
| V _{RRM} | repetitive peak reverse voltage | | - | - | 800 | V |
| I _{T(AV)} | average on-state current | half sine wave; $T_h \le 69 \degree C$ | - | - | 7.5 | A |
| I _{T(RMS)} | RMS on-state current | half sine wave; T _h ≤ 69 °C; <u>Fig. 1;</u> <u>Fig. 2; Fig. 3</u> | - | - | 12 | A |
| I _{TSM} | non-repetitive peak on- state current | half sine wave; T _{j(init)} = 25 °C; t _p = 10 ms; <u>Fig. 4; Fig. 5</u> | - | - | 120 | A |
| | | half sine wave; T _{j(init)} = 25 °C; t _p = 8.3 ms | - | - | 132 | A |
| Tj | junction temperature | | - | - | 125 | °C |
| Static chara | acteristics | | | | | |
| I _{GT} | gate trigger current | V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u> | - | 2 | 15 | mA |
| Dynamic ch | naracteristics | | | | | |

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| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|-----------|---|-----|------|-----|------|
| dV _D /dt | voltage | $ V_{DM} = 536 \text{ V}; \text{T}_{\text{j}} = 125 ^{\circ}\text{C}; \text{R}_{\text{GK}} = 100 \Omega; \\ (\text{V}_{\text{DM}} = 67\% \text{ of } \text{V}_{\text{DRM}}); \text{ exponential} \\ \text{waveform; gate open circuit; Fig. 12} $ | 200 | 1000 | - | V/µs |
| | | V_{DM} = 536 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; Fig. 12 | 50 | 130 | - | V/µs |

5. Pinning information

| | | ormation | | |
|-----|--------|-------------------------|---|----------------------|
| Pin | Symbol | Description | Simplified outline | Graphic symbol |
| 1 | К | cathode | mb | A - D I K |
| 2 | А | anode | | Ğ sym037 |
| 3 | G | gate | | Symosi |
| mb | n.c. | mounting base; isolated | () (| |

6. Ordering information

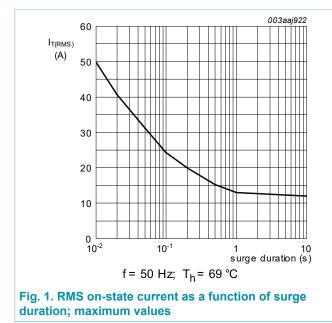
| Table 3. Ordering information | | | | | | |
|-------------------------------|---------|---|---------|--|--|--|
| Type number | Package | | | | | |
| | Name | Description | Version | | | |
| BT151X-800R | TO-220F | plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 "full pack" | SOT186A | | | |

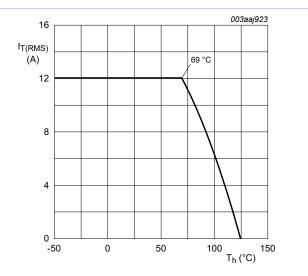
7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------|--|--|-----|-----|------|
| V _{DRM} | repetitive peak off-state voltage | | - | 800 | V |
| V _{RRM} | repetitive peak reverse voltage | | - | 800 | V |
| I _{T(AV)} | average on-state current | half sine wave; T _h ≤ 69 °C | - | 7.5 | А |
| I _{T(RMS)} | RMS on-state current | half sine wave; $T_h \le 69$ °C; <u>Fig. 1; Fig. 2;</u> <u>Fig. 3</u> | - | 12 | A |
| I _{TSM} | non-repetitive peak on- state current | half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5 | - | 120 | A |
| | | half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms | - | 132 | А |
| l ² t | I ² t for fusing | t _p = 10 ms; SIN | - | 72 | A²s |
| dl _T /dt | rate of rise of on-state current | I _G = 30 mA | - | 50 | A/µs |
| I _{GM} | peak gate current | | - | 2 | А |
| V _{RGM} | peak reverse gate voltage | | - | 5 | V |
| P _{GM} | peak gate power | | - | 5 | W |
| P _{G(AV)} | average gate power | over any 20 ms period | - | 0.5 | W |
| T _{stg} | storage temperature | | -40 | 150 | °C |
| Tj | junction temperature | | - | 125 | °C |

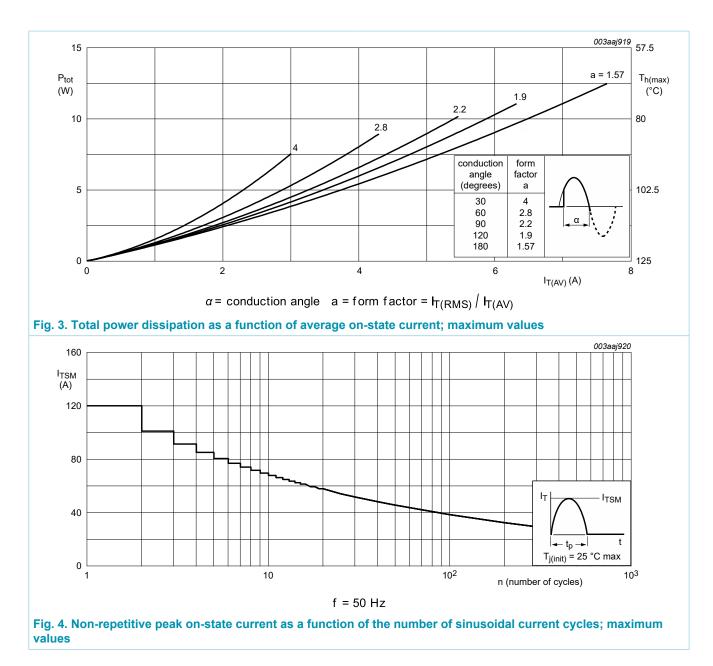






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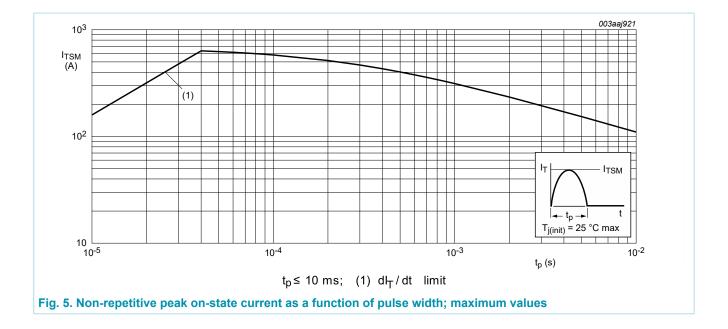
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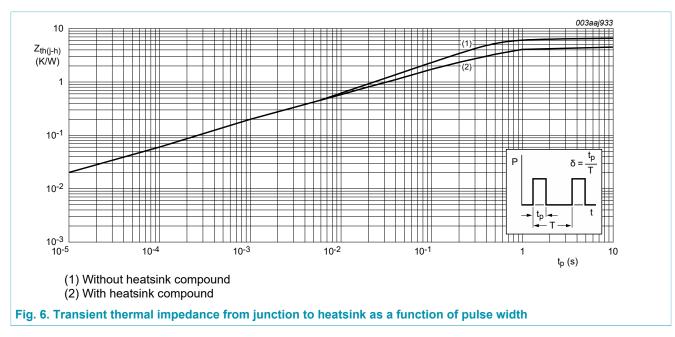
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8. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|--|-----------------------------------|-----|-----|-----|------|
| R _{th(j-h)} | thermal resistance | with heatsink compound; Fig. 6 | - | - | 4.5 | K/W |
| | from junction to heatsink | without heatsink compound; Fig. 6 | - | - | 6.5 | K/W |
| R _{th(j-a)} | thermal resistance from junction to ambient free air | in free air | - | 55 | - | K/W |



9. Isolation characteristics

Table 6. Isolation characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|------------------------|-----------------------|---|-----|-----|------|------|
| V _{isol(RMS)} | RMS isolation voltage | from all terminals to external heatsink; sinusoidal waveform; clean and dust free; 50 Hz \leq f \leq 60 Hz; RH \leq 65 %; T _h = 25 °C | - | - | 2500 | V |
| C _{isol} | isolation capacitance | from anode to external heatsink; f = 1 MHz; T _h = 25 °C | - | 10 | - | pF |

10. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|-----------------------------------|--|------|------|------|------|
| Static chara | acteristics | · · · · · | | | | |
| I _{GT} | gate trigger current | V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u> | - | 2 | 15 | mA |
| ۱ _L | latching current | V _D = 12 V; I _G = 0.1 A; T _j = 25 °C; <u>Fig. 8</u> | - | 10 | 40 | mA |
| I _H | holding current | V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u> | - | 7 | 20 | mA |
| V _T | on-state voltage | I _T = 23 A; T _j = 25 °C; <u>Fig. 10</u> | - | 1.4 | 1.75 | V |
| V _{GT} | gate trigger voltage | V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; Fig. 11 | - | 0.6 | 1 | V |
| | | V_D = 800 V; I _T = 0.1 A; T _j = 125 °C; Fig. 11 | 0.25 | 0.4 | - | V |
| I _D | off-state current | V _D = 800 V; T _j = 125 °C | - | 0.1 | 0.5 | mA |
| I _R | reverse current | V _R = 800 V; T _j = 125 °C | - | 0.1 | 0.5 | mA |
| Dynamic ch | naracteristics | | | | | |
| dV _D /dt | rate of rise of off-state voltage | V_{DM} = 536 V; T _j = 125 °C; R _{GK} = 100 Ω; (V_{DM} = 67% of V_{DRM}); exponential waveform; gate open circuit; Fig. 12 | 200 | 1000 | - | V/µs |
| | | V_{DM} = 536 V; T _j = 125 °C; (V_{DM} = 67% of V_{DRM}); exponential waveform; Fig. 12 | 50 | 130 | - | V/µs |
| t _{gt} | gate-controlled turn-on time | $\begin{split} I_{TM} &= 40 \text{ A}; V_D = 800 V; I_G = 100 \text{mA}; \\ \text{d} I_G/\text{d} t = 5 A/\mu\text{s}; T_j = 25 ^\circ\text{C} \end{split}$ | - | 2 | - | μs |
| t _q | commutated turn-off time | V_{DM} = 536 V; T _j = 125 °C; I _{TM} = 20 A; V_R = 25 V; (dI _T /dt) _M = 30 A/µs; dV _D / dt = 50 V/µs; R _{GK(ext)} = 100 Ω; (V _{DM} = 67% of V _{DRM}) | - | 70 | - | μs |

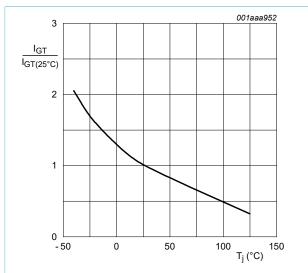


Fig. 7. Normalized gate trigger current as a function of junction temperature

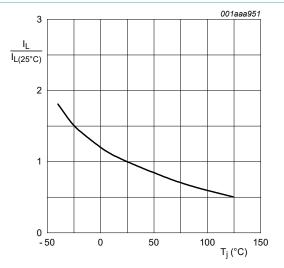
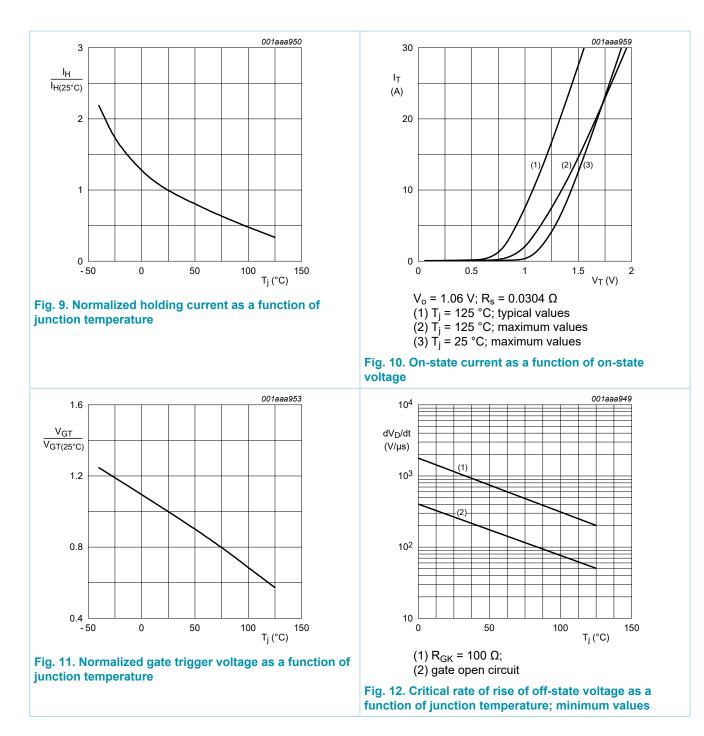


Fig. 8. Normalized latching current as a function of junction temperature

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11. Package outline

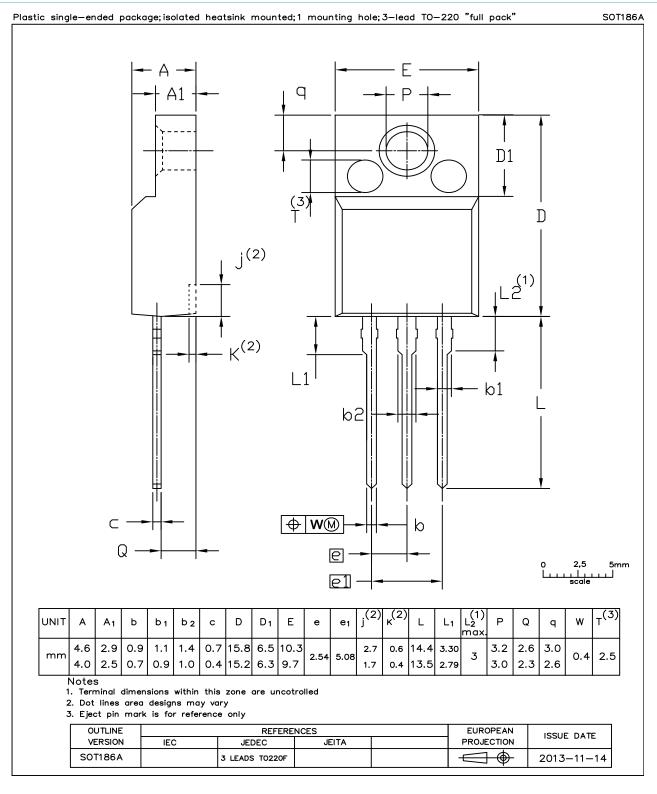


Fig. 13. Package outline TO-220F (SOT186A)

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|--------------------------------------|-------------------------------|---|
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